Unveiling the mechanisms of the spin Hall effect in Ta

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Spin-to-charge current interconversions are widely exploited for the generation and detection of pure spin currents and are key ingredients for future spintronic devices including spin-orbit torques and spin-orbit logic circuits. In the case of the spin Hall effect, different mechanisms contribute to the phenomenon and determining the leading contribution is peremptory for achieving the largest conversion efficiencies. Here, we experimentally demonstrate the dominance of the intrinsic mechanism of the spin Hall effect in highly resistive Ta. We obtain an intrinsic spin Hall conductivity for β -Ta of $-820 \pm 120(\hbar/e) \Omega^{-1}$ cm⁻¹ from spin absorption experiments in a large set of lateral spin valve devices. The predominance of the intrinsic mechanism in Ta allows us to linearly enhance the spin Hall angle by tuning the resistivity of Ta, reaching up to $-35 \pm 3\%$, the largest reported value for a pure metal.

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Condensed-matter systems with strong spin-orbit coupling (SOC) are extensively studied in the emerging field of spin orbitronics due to the novel effects and functionalities originated from the interplay between the charge and the spin of electrons. The spin Hall effect (SHE) in heavy metals [1,2] and Edelstein effect in Rashba interfaces [3–5] or in the Dirac surface states of topological insulators [3,6] are some of the phenomena discovered in this field. They all lead to spin-to-charge current interconversions, which are essential for future spin-orbit-based technological applications such as spin-orbit torques for magnetization switching [7–11] or spin-orbit logic [12,13].

The SHE generates a transverse pure spin current when a charge current is applied in a material with strong SOC [1,2]. Reciprocally, the inverse spin Hall effect (ISHE) is employed as a pure spin current detector because a measurable transverse charge current is created from the pure spin current. The spin-to-charge current conversion efficiency is given by the spin Hall angle, θ_{SH} , which is the ratio between the spin Hall conductivity (σ_{SH}) and the longitudinal conductivity (σ_{xx}). There are several mechanisms that contribute to the SHE. The intrinsic contribution is described by the Berry curvature [14] and the extrinsic contributions, including skew scattering [15] and side jump [16], are caused by the impurities present in the host material. The strength of each mechanism reveals the potential of the material as a spin-to-charge converter and indicates the path to enhance θ_{SH} . Determining the origin of the SHE in each material is thus mandatory for the development of efficient spin-orbit-based applications.

Heavy metals, such as Pt, Ta, and W, are characterized by strongly spin-orbit-coupled bands and theory predicts that the intrinsic contribution should dominate the SHE [2,17]. For the case of Pt, we recently obtained experimentally an intrinsic spin Hall conductivity, $\sigma_{\rm SH}^{\rm int}$, of $1600 \pm 150(\hbar/e) \,\Omega^{-1} \,{\rm cm}^{-1}$ [18], in good agreement with theoretical values [17,19]. However, this is not the case for Ta. Theoretical results suggest that β -Ta is characterized by a larger $\sigma_{\rm SH}^{\rm int} [-378(\hbar/e) \,\Omega^{-1} \,{\rm cm}^{-1}]$ [20] than α -Ta [from -80 to $-240(\hbar/e) \Omega^{-1} \text{ cm}^{-1}$] [17,20] and most experimental works are focused on β -Ta [21]. A large $\theta_{\rm SH}$ (-7.5%, using $\sigma_{\rm SH}$ in \hbar/e units [24]) was reported by Liu *et al.* for β -Ta [10], but discrepancies between values among different groups and techniques are common, ranging from -0.37% to -7.5% (using $\sigma_{\rm SH}$ in \hbar/e units) in the literature [10,20,25,31–34]. More importantly, there is no robust experimental evidence of which mechanism dominates the SHE in Ta, which hides the path to enhance θ_{SH} .

In this Rapid Communication, we employ the spin absorption technique in lateral spin valves (LSVs) to study the SHE in Ta. We analyze a wide range of resistivities of Ta and observe the dominance of the intrinsic mechanism in the SHE of Ta, obtaining $\sigma_{\text{SH}}^{\text{int}} = -821 \pm 115(\hbar/e)\Omega^{-1} \text{ cm}^{-1}$. We obtain the largest reported θ_{SH} for a pure metal, $-35 \pm 3\%$ (using σ_{SH} in \hbar/e units [24]). The spin absorption method allows us to extract the spin diffusion length (λ) and θ_{SH} of Ta in the same device by making two independent magnetotransport measurements [18,25–29,35–37], in contrast to many other techniques, such as spin pumping [38], spin-torque ferromagnetic resonance [39], spin Hall magnetoresistance [40], or magneto-optical

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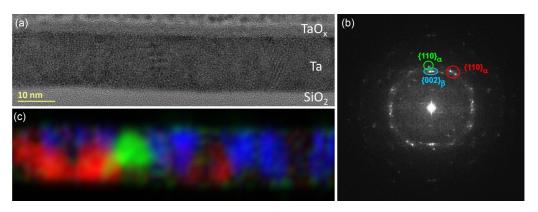


FIG. 1. (a) High-resolution TEM image of a cross section of the 15-nm-thick Ta film. (b) FFT pattern of the layer on (a). (c) Superposition of color-coded virtual dark-field images reconstructed from reflections marked on (b) showing distribution, size, and shape of β -Ta and α -Ta nanocrystals in the layer.

detection [30], where a thickness-dependent study is carried out to assign an effective λ and θ_{SH} to all samples, but not to each specific one. In addition, in the spin absorption technique, the spin Hall material is not in direct contact with the ferromagnet (FM) used as spin injector, which avoids proximity effects and magnetization-dependent scattering [41]. Furthermore, temperature-dependent measurements are easily accessible. With all these factors, we gain reliable insight into the mechanisms governing the SHE in Ta.

Different samples with Py/Cu lateral spin valves were fabricated on top of a SiO₂ (150 nm)/Si substrate by using multiple-step e-beam lithography, subsequent metal deposition, and lift-off. One of the LSVs contains a middle Ta wire and the other one, the reference LSV, does not. First, Py electrodes were patterned, with an interelectrode distance of 1 μ m, and 30 nm of Py were e-beam evaporated at 0.6 Å/s and 1.4×10^{-8} Torr. In the second step, 10 or 15 nm of Ta were sputtered at 1.6 Å/s, 20 W of power, 8×10^{-8} Torr of base pressure, and 1.5×10^{-3} Torr of Ar pressure. In the third step, a 100-nm-wide channel was patterned and ~ 100 nm of Cu were thermally evaporated at 3 Å/s and 1.2×10^{-8} Torr. In order to remove the \sim 2.4-nm-thick native oxide from the Ta wire [see Fig. 1(a)] and achieve electrically transparent Ta/Cu and Py/Cu interfaces, the surfaces of the Py and Ta were in situ cleaned by Ar-ion beam etching before the Cu deposition. A transmission electron microscopy (TEM) study was performed on a Titan 60-300 electron microscope (FEI Co., The Netherlands) equipped with an imaging Cs corrector. High-resolution TEM (HR-TEM) images were obtained at 300 kV at negative Cs imaging conditions [42]. The samples for TEM were fabricated by the standard focused ion beam (FIB) protocol [43]. All transport measurements described below were carried out in a ⁴He flow cryostat (applying external magnetic field H and varying temperature T) using the lock-in technique (173 Hz and 575 μ A).

Structural characterization was performed in 10- and 15-nm-thick Ta films grown with the same conditions as the middle Ta wire. Figure 1(a) shows the HR-TEM image of a cross section of the 15-nm-thick Ta film. The film is polycrystalline with seemingly random distribution of crystal orientations. As electron diffraction from such thin and

laterally extended structure is technically difficult to obtain, we use its mathematical analog instead: 2D fast Fourier transform (FFT) of a high-resolution image [Fig. 1(b)]. The FFT pattern reveals the coexistence of two types of reflections: with $d \sim$ $0.26 \,\mathrm{nm}$, which can be attributed to $\{002\}$ lattice planes of β -Ta (either triclinic or hexagonal), and $d \sim 0.23$ nm, which can be attributed to {110} lattice planes of cubic α -Ta [44]. It is remarkable that although α -Ta nanocrystals have random orientations, i.e., its reflections are uniformly distributed on the ring of the FFT pattern, the β -Ta phase shows a clear texture with the c axis normal to the surface. Figure 1(c) combines virtual dark-field images, reconstructed from the reflections marked in Fig. 1(b). The β -Ta phase forms a continuous, yet heavily distorted, layer on top of α -Ta nanocrystals. Grazing incidence x-ray diffraction confirms the coexistence of β -Ta and α -Ta phases in both films [44]. The resistivity of these thin films is 209 $\mu\Omega$ cm (10 nm) and 193 $\mu\Omega$ cm (15 nm) at room temperature and shows a negative temperature coefficient of resistance (TCR) [44], which is characteristic for the β phase [21,45].

Figure 2(a) shows the scanning electron microscopy (SEM) image of a LSV with a middle Ta wire. We inject a charge current from the Py electrode to the left side of the Cu channel. Due to the spin accumulation generated at the Py/Cu interface, spins diffuse to both sides of the Cu channel. On the right side, where no charge current is present, a pure spin current flows along the Cu channel, which is characterized by a long spin diffusion length [46-49]. The pure spin current reaches the second Py electrode, where the corresponding spin voltage is measured. This spin voltage is normalized to the injected current, obtaining the nonlocal resistance, $R_{\rm NL}$, which depends on the relative magnetization of the two Py electrodes. The difference of the measured $R_{\rm NL}$ at parallel and antiparallel configurations of the Py electrodes defines the spin signal, $\Delta R_{\rm NL}$. The spin signal of the reference LSV, $\Delta R_{\rm NL}^{\rm ref}$, is larger than that of the LSV with the middle Ta wire, $\Delta R_{\rm NI}^{\rm abs}$ [see Fig. 2(b) for the case of device D1]. In the latter case, the Ta wire absorbs part of the spin current that flows along the Cu channel, so that the pure spin current reaching the detector is reduced. The ratio between the two spin signals is described by the one-dimensional (1D) spin diffusion model for

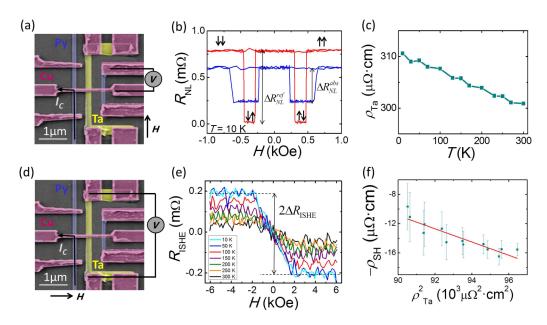


FIG. 2. (a) SEM image of a Py/Cu LSV with a middle Ta wire. The nonlocal measurement configuration and the magnetic field orientation are shown. (b) Nonlocal resistance vs magnetic field measured at 10 K in device D1 using the configuration shown in (a) for a Py/Cu LSV with (blue line) and without (red line) a middle Ta wire. (c) Temperature dependence of the resistivity of Ta in device D1. (d) Same SEM image as in (a), showing the ISHE measurement configuration and the magnetic field orientation. (e) ISHE resistance vs magnetic field measured at selected temperatures in device D1 using the configuration shown in (d). (f) Spin Hall resistivity as a function of the square of the longitudinal resistivity of Ta. Red solid line is the fitting of the data to Eq. (4).

transparent interfaces [18]:

$$\frac{\Delta R_{\rm NL}^{\rm abs}}{\Delta R_{\rm NL}^{\rm ref}} = \frac{2Q_{\rm Ta}\left[\sinh\left(\frac{L}{\lambda_{\rm Cu}}\right) + 2Q_{\rm Py}e^{\frac{L}{\lambda_{\rm Cu}}} + 2Q_{\rm Py}e^{\frac{L}{\lambda_{\rm Cu}}}\right]}{\cosh\left(\frac{L}{\lambda_{\rm Cu}}\right) - \cosh\left(\frac{L-2l}{\lambda_{\rm Cu}}\right) + 2Q_{\rm Py}\sinh\left(\frac{l}{\lambda_{\rm Cu}}\right)e^{\frac{L-l}{\lambda_{\rm Cu}}} + 2Q_{\rm Ta}\sinh\left(\frac{L}{\lambda_{\rm Cu}}\right) + 4Q_{\rm Py}Q_{\rm Ta}e^{\frac{L}{\lambda_{\rm Cu}}} + 2Q_{\rm Py}e^{\frac{L}{\lambda_{\rm Cu}}} + 2Q_{\rm Py}^{2}e^{\frac{L}{\lambda_{\rm Cu}}} + 4Q_{\rm Py}^{2}Q_{\rm Ta}e^{\frac{L}{\lambda_{\rm Cu}}},$$
(1)

where $Q_{Py(Ta)} = \frac{R_{Py(Ta)}}{R_{Cu}}$, being $R_{Cu} = \frac{\lambda_{Cu}\rho_{Cu}}{w_{Cu}t_{Cu}}$, $R_{Py} = \frac{\lambda_{Ta}\rho_{Ta}}{w_{Cu}w_{Py}(1-\alpha_{Py}^2)}$, and $R_{Ta} = \frac{\lambda_{Ta}\rho_{Ta}}{w_{Cu}w_{Ta} \tanh(\frac{t_{Ta}}{\lambda_{Ta}})}$ the spin resistances of the Cu channel, Py electrodes, and Ta wire, respectively. $\rho_{Cu,Py,Ta}$, $\lambda_{Cu,Py,Ta}$, $w_{Cu,Py,Ta}$ and $t_{Cu,Ta}$ are the resistivities, spin diffusion lengths, widths and thicknesses, respectively. The temperature dependence of ρ_{Ta} for device D1 [see Fig. 2(c)] shows a negative TCR, as in the thin films [44]. α_{Pv} is the spin polarization of Py. L is the distance between the two Py electrodes, whereas l is the distance between the Py injector and Ta wire. A 1D approximation is valid because λ_{Cu} is much longer [46–50] than the width of the Py and Ta nanowires. Since the spin resistances of Py and Cu are well known from our previous works [48-50], we can extract λ_{Ta} from Eq. (1) [51]. We obtain $\lambda_{Ta} = 2.39 \pm 0.03$ nm for device D1 at 10 K, which is in reasonable agreement with previous reports [25,31-33,53]. We repeated this procedure for different temperatures between 10 and 300 K.

Once demonstrated that Ta absorbs part of the spin current flowing along Cu, we measure the ISHE using the configuration shown in Fig. 2(d). By applying the magnetic field in plane, perpendicular to the easy axis of the Py electrodes, we inject a pure spin current into the Cu wire. This pure spin current will flow through the Cu channel and will partially be absorbed by the Ta wire, where it will be converted into a charge current due to the ISHE. The charge current generated along the Ta wire will be detected as a voltage drop. Normalizing the measured voltage drop with the injected current, we define the ISHE resistance, R_{ISHE} . If we reverse the magnetic field, the spins injected to the Cu channel will point in the opposite direction and, therefore, they will be deflected to the other side in the Ta wire, giving rise to the opposite R_{ISHE} [see Fig. 2(e) for the case of device D1]. The difference between these two R_{ISHE} values is twice the ISHE signal: $2\Delta R_{ISHE}$. Note that the obtained ΔR_{ISHE} in Ta is negative, i.e., opposite to the one obtained in Pt [18,29] and Au [26,29], as expected [17]. We measured R_{ISHE} at different temperatures and, for the sake of clarity, only a selection is shown in Fig. 2(e). We observe that ΔR_{ISHE} decreases with increasing temperature.

The spin Hall resistivity, $\rho_{\rm SH}$, a convenient quantity to quantify the SHE, is related to $\theta_{\rm SH}$ as $\theta_{\rm SH} = -\rho_{\rm SH}/\rho_{\rm xx} = \sigma_{\rm SH}/\sigma_{\rm xx}$ [24], where $\rho_{\rm xx}$ is the longitudinal resistivity ($\rho_{\rm Ta}$ for Ta). The relation between $\Delta R_{\rm ISHE}$ and $\rho_{\rm SH}$ is given by [25]

$$\rho_{\rm SH} = -\frac{w_{\rm Ta}}{x_{\rm Cu,Ta}} \left(\frac{I_{\rm c}}{\overline{I_{\rm s}}}\right) \Delta R_{\rm ISHE},\tag{2}$$

where $x_{Cu,Ta}$ is the shunting factor which takes into account the current in the Ta that is shunted through the Cu and is obtained from numerical calculations using a finite elements method [54]. The shunting factor must be considered to avoid underestimations in the spin Hall angle. $\overline{I_s}$ is the effective spin current that contributes to the ISHE in Ta and is given by [18,29]

$$\frac{\overline{I}_{s}}{I_{c}} = \frac{\lambda_{\text{Ta}} \left(1 - e^{-\frac{Tr_{a}}{\lambda_{\text{Ta}}}}\right)^{2}}{t_{\text{Ta}} \left(1 - e^{-\frac{2Tr_{a}}{\lambda_{\text{Ta}}}}\right)^{2}} \frac{2\alpha_{\text{Py}} \left[\mathcal{Q}_{\text{Py}} \sinh\left(\frac{L-l}{\lambda_{\text{Cu}}}\right) + \mathcal{Q}_{\text{Py}} e^{\frac{L-l}{\lambda_{\text{Cu}}}}\right]}{\cosh\left(\frac{L}{\lambda_{\text{Cu}}}\right) - \cosh\left(\frac{L-2l}{\lambda_{\text{Cu}}}\right) + 2\mathcal{Q}_{\text{Py}} \sinh\left(\frac{l}{\lambda_{\text{Cu}}}\right) e^{\frac{L-l}{\lambda_{\text{Cu}}}} + 2\mathcal{Q}_{\text{Ta}} \sinh\left(\frac{L}{\lambda_{\text{Cu}}}\right) + 4\mathcal{Q}_{\text{Py}} \mathcal{Q}_{\text{Ta}} e^{\frac{L}{\lambda_{\text{Cu}}}} + 2\mathcal{Q}_{\text{Py}} e^{\frac{L}{\lambda_{\text{Cu}}}} + 2\mathcal{Q}_{\text{Py}} e^{\frac{L}{\lambda_{\text{Cu}}}} + 2\mathcal{Q}_{\text{Py}} e^{\frac{L}{\lambda_{\text{Cu}}}} + 4\mathcal{Q}_{\text{Py}}^{2} \mathcal{Q}_{\text{Ta}} e^{\frac{L}{\lambda_{\text{Cu}}}}.$$
(3)

Note that quantifying ρ_{SH} requires the value of λ_{Ta} that we extract from the spin absorption experiment.

Phenomenologically, each mechanism of the SHE contributes to ρ_{SH} with a different resistivity dependence [55]:

$$-\rho_{\rm SH} = \sigma_{\rm SH}^{\rm int} \rho_{\rm Ta}^2 + \sigma_{\rm SH}^{\rm sj} \rho_{\rm Ta,0}^2 + \alpha_{\rm ss} \rho_{\rm Ta,0}, \qquad (4)$$

where $\sigma_{\rm SH}^{\rm int}$ is the intrinsic spin Hall conductivity of Ta, $\sigma_{\rm SH}^{\rm sl}$ is the one corresponding to the side jump, $\alpha_{\rm ss}$ is the skew scattering angle, and $\rho_{\rm Ta,0}$ is the residual resistivity of Ta. In order to unveil the weight of each mechanism, we analyze the dependence of $-\rho_{\rm SH}$, obtained experimentally using Eqs. (2) and (3), with $\rho_{\rm Ta}$, which is changed with the temperature, see Fig. 2(c). In Fig. 2(f), we plot $-\rho_{\rm SH}$ against $\rho_{\rm Ta}^2$ and fit this data to a linear function with the slope that corresponds to $\sigma_{\rm SH}^{\rm int}$ and the intercept to the sum of the skew scattering and side jump contributions. We extract $\sigma_{\rm SH}^{\rm int} = -910 \pm 130(\hbar/e) \Omega^{-1} \, {\rm cm}^{-1}$ and $\sigma_{\rm SH}^{\rm sj} \rho_{\rm Ta,0}^2 + \alpha_{\rm ss} \rho_{\rm Ta,0} = 71 \pm 12(e/\hbar) \, \mu\Omega$ cm from device D1.

The variation of ρ_{Ta} with temperature is very small, around 3% as shown in Fig. 2(c), thus the studied resistivity range is relatively short. In order to get a more complete study, covering a broader range of resistivities, we use additional devices (D2–D7) containing Ta wires with different $\rho_{Ta,0}$ (see Table I). In order to tune $\rho_{Ta,0}$, we modify the width and thickness of the Ta wires. For each device, we measure first the spin absorption signal at 10 K, in order to extract λ_{Ta} of each Ta wire (see Table I). We observe that λ_{Ta} is small for all devices, between 0.8 and 2.4 nm, and has no clear tendency with the resistivity.

Next, we measure the ISHE for each device at 10 K, as shown in Fig. 3(a) for three selected devices that are characterized by different $\rho_{Ta,0}$. We observe that $|\Delta R_{ISHE}|$ increases with $\rho_{Ta,0}$. This result is consistent for all the studied devices, as shown in the inset of Fig. 3(a). Using Eqs. (2) and (3), we extract ρ_{SH} for each device, which is plotted in Fig. 3(b) as a function of $\rho_{Ta,0}$. A clear increase of $|\rho_{SH}|$ with $\rho_{Ta,0}$ is observed.

TABLE I. Thickness, width, resistivity, spin diffusion length and spin Hall angle of the Ta wires obtained in this work. The shunting factor ($x_{Cu,Ta}$) of the different devices is shown. All data correspond to 10 K.

Device	t _{Ta} (nm)	w _{Ta} (nm)	ρ_{Ta} ($\mu\Omega cm$)	λ _{Ta} (nm)	$ heta_{ m SH}$ (%)	x _{Cu,Ta}
D1	15	270	311	2.39 ± 0.03	-5.0 ± 0.3	0.09547
D2	15	270	330	1.27 ± 0.02	-7.6 ± 0.6	0.09556
D3	15	270	369	0.81 ± 0.02	-11.3 ± 0.9	0.10198
D4	10	273	401	1.52 ± 0.05	-10 ± 1	0.04106
D5	10	224	483	1.31 ± 0.02	-13.2 ± 0.9	0.04451
D6	10	187	493	2.22 ± 0.06	-17 ± 1	0.04096
D7	10	195	648	0.76 ± 0.03	-35 ± 3	0.03868

Since, at low temperature, Eq. (4) can be rewritten as $\frac{-\rho_{\rm SH}}{\rho_{\rm Ta,0}} = (\sigma_{\rm SH}^{\rm int} + \sigma_{\rm SH}^{\rm sj})\rho_{\rm Ta,0} + \alpha_{\rm ss}$, we can perform a linear fit of $\frac{-\rho_{\rm SH}}{\rho_{\rm Ta,0}}$ against $\rho_{\rm Ta,0}$. Using the experimental data of all devices, see the inset of Fig. 3(b), we extract $\sigma_{\rm SH}^{\rm int} + \sigma_{\rm SH}^{\rm sj} = -820 \pm 120(\hbar/e) \,\Omega^{-1} \,\rm cm^{-1}$ from the slope and $\alpha_{\rm ss} = 0.21 \pm 0.05$ from the intercept. The obtained $\sigma_{\rm SH}^{\rm int}$ from the previous fit in device D1 ($\sigma_{\rm SH}^{\rm int} = -910 \pm 130(\hbar/e) \,\Omega^{-1} \,\rm cm^{-1}$), is compatible with the $\sigma_{\rm SH}^{\rm int} + \sigma_{\rm SH}^{\rm sj} = -820 \pm 120(\hbar/e) \,\Omega^{-1} \,\rm cm^{-1}$ result obtained considering all devices. This indicates that $\sigma_{\rm SH}^{\rm sj}$ is negligible, which is expected in a pure metal [1,56,57]. Therefore, from the previous fit in device D1, we can consider $\alpha_{\rm ss}\rho_{\rm Ta,0} = 71 \pm 12(e/\hbar) \,\mu\Omega$ cm, which leads to $\alpha_{\rm ss} = 0.23 \pm 0.04$. This skew scattering angle is also consistent with the last result, $\alpha_{\rm ss} = 0.21 \pm 0.05$, obtained using all devices at low temperature.

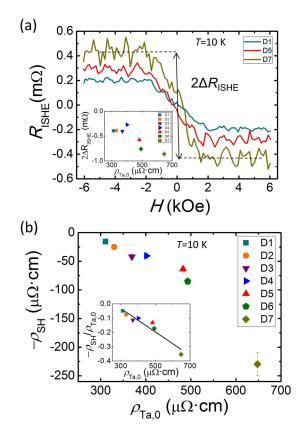


FIG. 3. (a) ISHE resistance vs magnetic field at 10 K for selected devices measured using the configuration shown in Fig. 2(d). Inset: ISHE signal vs residual resistivity of Ta for all devices at 10 K. (b) Spin Hall resistivity vs residual resistivity of Ta for all devices at 10 K. Inset: Ratio of the spin Hall resistivity and residual resistivity of Ta vs residual resistivity of Ta for all devices at 10 K. Black solid line is the fitting of the data to Eq. (4) at low temperature.

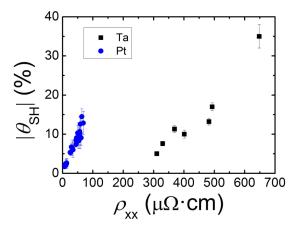


FIG. 4. Longitudinal resistivity dependence of the absolute value of the spin Hall angle of Ta (black solid squares) and Pt (blue solid circles; from Ref. [18]).

Considering that the upper part of the Ta wire, where the spin absorption from Cu occurs, is composed by β -Ta grains, see Fig. 1(c), and that the spin diffusion length of Ta is a few nanometers, see Table I, we can safely consider that the spin-to-charge conversion occurs in the upper β -Ta grains. Therefore, the obtained $\sigma_{\text{SH}}^{\text{int}}$, $-820 \pm 120(\hbar/e) \,\Omega^{-1} \,\text{cm}^{-1}$, is dominated by β -Ta. In the literature, we cannot identify reliable quantitative predictions for a polycrystalline sample including β -Ta. In Ref. [20] they extract $-378(\hbar/e) \Omega^{-1} \text{ cm}^{-1}$ for clean β -Ta based on first principles and Berry curvature based spin transport calculations. In order to model disorder they exploit the supercell as well as the virtual crystal approximation but do not present results showing the variation of the Fermi energy for β -Ta. However, in a system such as β -Ta it can be expected that $\sigma_{\rm SH}^{\rm int}$ changes dramatically as a function of the Fermi energy as shown in Ref. [58] for β -W. Using Fig. 2 of Ref. [58] and assuming the virtual crystal approximation, going from β -W to β -Ta would reduce the Fermi energy by ~1.3 eV and result in σ_{SH}^{int} quantitatively close to the value identified in this work. The obtained $\alpha_{ss} = 0.21 \pm 0.05$ corresponds to a remarkable extrinsic contribution of $\theta_{\rm SH} =$ 21%, independent of the residual resistivity. Nevertheless, due to the opposite signs of the intrinsic and extrinsic contributions and the high resistivity, the skew scattering is counterbalanced by the intrinsic contribution, which becomes dominant.

Figure 4 shows the absolute value of θ_{SH} of Ta as a function of ρ_{Ta} , together with that of Pt obtained in our previous work

[18]. We are able to increase linearly $\theta_{\rm SH}$ of Ta up to $-35 \pm$ 3% by simply increasing ρ_{Ta} (following the definition used by other groups, using σ_{SH} in units of $\hbar/2e$, our θ_{SH} is -70% [24]). This is a clear indication of the dominance of the intrinsic mechanism in the SHE of Ta. We observed a similar tendency in Pt in the intrinsic regime, but with a larger slope, as shown in Fig. 4, due to the larger σ_{SH}^{int} in Pt. Finally, we can compare the obtained θ_{SH} values for Ta with those found in literature using alternative techniques to measure the SHE. Employing ferromagnetic resonance-based techniques, θ_{SH} values between -1% and -7.5% (using σ_{SH} in \hbar/e units [24]) have been reported for $\rho_{Ta} \sim 190 \,\mu\Omega \,\mathrm{cm} \, [10,31-33]$. Employing longitudinal spin Seebeck effect, $\theta_{SH} = -0.5\%$ (using σ_{SH} in \hbar/e units [24]) has been reported for $\rho_{Ta} \sim 350 \,\mu\Omega \,\mathrm{cm}$ [20]. Although it is difficult to compare values from different techniques because of potential systematic misestimations, the larger θ_{SH} values obtained in our work can be clearly ascribed to the higher resistivities achieved in our Ta nanostructures in combination with the predominance of the intrinsic mechanism in Ta.

To conclude, we experimentally determine the intrinsic mechanism as the leading contribution of the SHE in highly resistive Ta. We extract $\sigma_{\rm SH}^{\rm int}$ for β -Ta to be $-820 \pm 120(\hbar/e) \Omega^{-1} \, {\rm cm}^{-1}$, which is constant in a broad range of resistivities. The predominance of the intrinsic mechanism reveals the path to increase $\theta_{\rm SH}$ in Ta: increasing the resistivity of the metal. With this approach, by measuring with the spin absorption technique, we can systematically vary $\theta_{\rm SH}$ from $-5.0 \pm 0.3\%$ up to $-35 \pm 3\%$, achieving the largest conversion efficiency reported so far for a pure metal. This work unveils the intrinsic potential of Ta as a spin-to-charge converter, definitely appealing and promising for spin-orbit-based technological applications.

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